

**F1** E502650

### **Features**

- Halogen Free Available Upon Request By Adding Suffix "-HF"
- Glass Passivated Chip Junction
- Moisture Sensitivity Level 1
- Surface Mount Package
- Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant (Note 1)("P" Suffix Designates RoHS Compliant. See Ordering Information)

# Maximum Ratings @ 25°C (Unless Otherwise Specified)

Parameter	Symbol	Value									
		MB 05S	MB 1S	MB 2S	MB 4S	MB 6S	MB 8S	MB 10S	Unit		
Peak Repetitive Reverse Voltage	$V_{RRM}$										
Working Peak Reverse Voltage	$V_{RWM}$	50	50 100	50	50 100	200	400	600	800	1000	V
DC Blocking Voltage	$V_R$										
RMS Reverse Voltage	$V_{RMS}$	35	70	140	280	420	560	700	٧		
Average Rectified Forward Current @ See Fig.1	I <sub>F(AV)</sub>	0.5 <sup>(Note 2)</sup> 0.8 <sup>(Note 3)</sup>				Α					
Non-Repetitive Peak Surge Current @ 8.3ms Half Sine Wave	35				Α						
Non-Repetitive Peak Surge Current @ 1ms Square Wave	I <sub>FSM</sub>	60						A			
Current Squared Time @1ms≤t≤8.3ms	l <sup>2</sup> t	5			A <sup>2</sup> s						

# **Marking Code**

Part Number	Marking Code
MB05S	MB05S
MB1S	MB1S
MB2S	MB2S
MB4S	MB4S
MB6S	MB6S
MB8S	MB8S
MB10S	MB10S

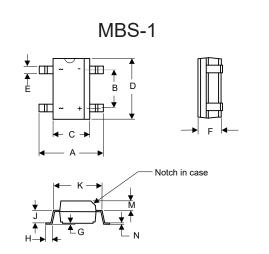
# **Internal Structure**

Simplified Outline	Graphic Symbol
MCC + XXXX	***
XXXX = Marking Code	$\underset{\sim}{\swarrow}$

# Note:

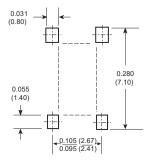
- 1. High temperature solder exemption applied, see EU directive annex 7a.
- 2.On glass epoxy P.C.B. mounted on 0.05 x 0.05"(1.3 x 1.3mm)pads
- 3.On aluminum substrate P.C.B. with an area of 0.8" x 0.8"(20 x 20mm) mounted on
- 0.05 x 0.05"(1.3x 1.3mm) solder pad

# 0.5 Amp Single Phase Bridge Rectifier 50 to 1000 Volts



DIMENSIONS							
DIM	INC	HES	M	M	NOTE		
DIIVI	MIN	MAX	MIN	MAX	NOTE		
Α	0.252	0.276	6.40	7.00			
В	0.095	0.106	2.41	2.70			
С	0.142	0.165	3.60	4.20			
D	0.179	0.195	4.55	4.95			
E	0.019	0.031	0.50	0.80			
F	0.090	0.106	2.30	2.70			
G	0.002	0.008	0.05	0.20			
Н	0.027	0.043	0.70	1.10			
J	0.058	0.062	1.47	1.57			
K	0.195	0.205	4.95	5.21			
М	0.039	0.049	0.99	1.24			
N	0.006	0.016	0.15	0.41			

# Suggested Solder Pad Layout





# Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TJ	Operating Junction Temperature Range		-55		150	°C
T <sub>stg</sub>	Storage Temperature Range		-55		150	°C
Rth <sub>(J-L)</sub>	Thermal Resistance from Junction to Lead	Note 1		20		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 1		80		°C/W
Rth <sub>(J-A)</sub>	Thermal Resistance from Junction to Ambient	Note 2		70		°C/W

### Note:

# Electrical Characteristics @ 25°C Unless Otherwise Specified(Per Diode)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =0.4A;T <sub>J</sub> =25°C			1.0	V
Reverse Current	I <sub>R</sub>	at Rated $V_R;T_J=25^{\circ}C$ at Rated $V_R;T_J=125^{\circ}C$			5 100	μΑ
Junction Capacitance	CJ	V <sub>R</sub> =4V;f=1MHz;T <sub>J</sub> =25°C		13	35	pF

<sup>1.</sup>On glass epoxy P.C.B. mounted on 0.05 x 0.05"(1.3 x 1.3mm)pads.

<sup>2.</sup>On aluminum substrate P.C.B. with an area of 0.8" x 0.8"(20 x 20mm) mounted on 0.05 x 0.05"(1.3x 1.3mm) solder pad.



# **Curve Characteristics**

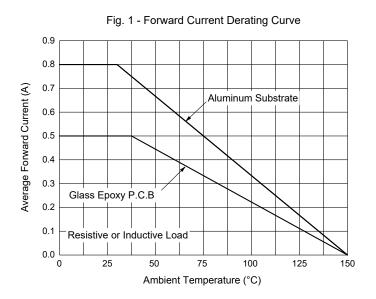


Fig. 3 - Typical Forward Characteristics 10 Forward Current (A) T<sub>J</sub>=25°C <u>≤</u> =75°C = =125°C 0.01 0.2 0.4 8.0 1.0 1.2 1.4 1.6 0.6 Forward Voltage (V)

Fig. 5 - Typical Capacitance Characteristics 30 T<sub>J</sub>=25°C f=1MHz 25 Junction Capacitance (pF) 20 15 5 0 0 5 15 20 25 30 10 Reverse Voltage (V)

Current

35

30

25

20

15

8.3 ms Single Half Sine-Wave

0

1 10

Number of Cycles at 60 Hz

Fig. 2 - Maximum Non-Repetitive Peak Forward Surge

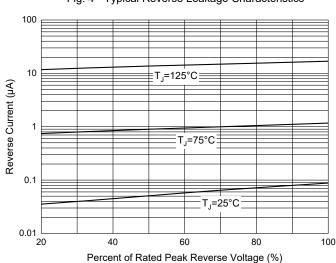


Fig. 4 - Typical Reverse Leakage Characteristics



# **Ordering Information**

Device	Packing		
Part Number-TP	Tape&Reel:3Kpcs/Reel		

Note: Adding "-HF" Suffix For Halogen Free, eg. Part Number-TP-HF

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